

Workshop on CMOS Active Pixel Sensors for Particle Tracking (CPIX14)

Tuesday, 16 September 2014

3D integration and interconnection technologies - Bethe Forum (16:45 - 17:45)

-Conveners: Jochen Dingfelder

time	[id] title	presenter
16:45	[24] MAPS are for amateurs, professionals do 3D	Dr DEPTUCH, Grzegorz
17:15	[27] Advances in Bonding technologies (chip to wafer and wafer to wafer)	Mr YAREMA, Ray